

## C1206X331KCRACTU

Aliases (C1206X331KCRAC7800) SMD Comm X7R HV Flex, Ceramic, 330 pF, 10%, 500 VDC, X7R, SMD, MLCC, FT-CAP, Temperature Stable, 1206, 1.5 mm



Click here for the 3D model.

General Information	
Series	SMD Comm X7R HV Flex
Style	SMD Chip
Description	SMD, MLCC, FT-CAP, Temperature Stable
Features	FT-CAP, Temperature Stable
RoHS	Yes
Termination	Flexible Termination
Marking	No
AEC-Q200	No
Typical Component Weight	25 mg
Shelf Life	78 Weeks
MSL	1

Dimensions		Sp
Chip Size	1206	Ca
L	3.3mm +/-0.4mm	М
W	1.6mm +/-0.35mm	Тс
Т	1mm +/-0.20mm	V
S	1.5mm MIN	Di
В	0.6mm +/-0.25mm	Te
		Тс

Packaging Specifications	
Packaging	T&R, 180mm, Plastic Tape
Packaging Quantity	2500

Specifications	
Capacitance	330 pF
Measurement Condition	1 kHz 1.0Vrms
Tolerance	10%
Voltage DC	500 VDC
Dielectric Withstanding Voltage	750 VDC
Temperature Range	-55/+125°C
Temp. Coefficient	X7R
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	15%, 1kHz 1.0Vrms
Dissipation Factor	2.5%1kHz1.0Vrms
Aging Rate	3% Loss/Decade Hour: Referee Time is 1000 Hours
Insulation Resistance	100 GOhms

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